

Prior to use, carefully read the instructions for use.



Consult
Instructions
for Use

SELECT ETCHING MODE



10-15
sec.



10-15
sec.

Etch for 10-15 sec.,
rinse for 5 sec. and dry.

BONDING PROCEDURE



Apply G-Premio
BOND and wait
10 sec.



Dry.



Light curing time

| Light curing unit | Distance from light guide tip | |
|---|-------------------------------|---------|
| | <10mm | >10mm |
| Halogen / LED (700 mW/cm ²) | 10 sec. | 20 sec. |
| High power LED (>1200 mW/cm ²) | 5 sec. | 10 sec. |

INTRAORAL REPAIR



Roughen surface.
Rinse and dry.



Apply Ceramic
Primer II on ceramic
surfaces. Dry.



Apply G-Premio
BOND to all
surfaces and wait
10 sec.



Dry.



Light cure.

HYPERSENSITIVITY TREATMENT



Apply G-Premio
BOND. Wait 10 sec.



Dry.



Light cure.



Remove
unpolymerized layer.